19-2043; Rev 1; 8/01

MAXIM

µP Supervisory Circuits in 4-Bump (2 × 2) Chip-Scale Package

General Description

The MAX6400–MAX6405 is a family of ultra-low power microprocessor (µP) supervisory circuits used for monitoring battery, power-supply, and regulated system voltages. Each device contains a precision bandgap reference comparator and is trimmed to specified trip threshold voltages. These devices provide excellent circuit reliability and low cost by eliminating external components and adjustments when monitoring system voltages from 2.5V to 5.0V. A manual reset input is also included.

The MAX6400–MAX6405 assert a reset signal whenever the V_{CC} supply voltage falls below a preset threshold. These devices are differentiated by their output logic configurations and preset threshold voltages. The MAX6400/MAX6403 (push-pull) and the MAX6402/MAX6405 (open-drain) have an active-low reset ($\overline{RESET}$ is logic low when V_{CC} is below V_{TH}). The MAX6401/MAX6404 have an active-high push-pull output (RESET is logic high when V_{CC} is below V_{TH}). All parts are guaranteed to be in the correct output logic state for V_{CC} down to 1V. The reset circuit is designed to ignore fast transients on V_{CC}. The MAX6400/MAX6401/MAX6402 have voltage thresholds between 2.20V and 3.08V in approximately 100mV increments. The MAX6403/MAX6404/MAX6405 have voltage thresholds between 3.30V and 4.63V in approximately 100mV increments.

Ultra-low supply current of 500nA (MAX6400/MAX6401/MAX6402) makes these parts ideal for use in portable equipment. These devices are available in 4-bump chip-scale packages (UCSP™)

Applications

Portable/Battery-Powered Equipment

Cell Phones

PDAs

MP3 Players

Pagers

Selector Guide

PART	NOMINAL V_{TH} (V)	$\overline{RESET}$/RESET OUTPUT TYPE
MAX6400	2.20 to 3.08	Push-Pull, Active-Low
MAX6401	2.20 to 3.08	Push-Pull, Active-High
MAX6402	2.20 to 3.08	Open-Drain, Active-Low
MAX6403	3.30 to 4.63	Push-Pull, Active-Low
MAX6404	3.30 to 4.63	Push-Pull, Active-High
MAX6405	3.30 to 4.63	Open-Drain, Active-Low

Features

- **Ultra-Small 4-Bump (2 × 2) Chip-Scale Package, (Package Pending Full Qualification—Expected Completion Date 6/30/01. See *UCSP Reliability* Section for More Details.)**
- **70% Smaller Than SC70 Package**
- **Ultra-Low 500nA (typ) Supply Current (MAX6400/MAX6401/MAX6402)**
- **Factory-Trimmed Reset Thresholds from 2.20V to 4.63V in Approximately 100mV Increments**
- **±2.5% Threshold Accuracy -40°C to +85°C**
- **Factory-Set 100ms (min) Reset Timeout Period**
- **Manual Reset Input**
- **Guaranteed Reset Valid to V_{CC} = 1.0V**
- **Three Reset Output Logic Options: Active-Low Push-Pull, Active-High Push-Pull, and Active-Low Open-Drain.**
- **Immune to Short V_{CC} Transients**
- **No External Components**

Ordering Information

PART	TEMP. RANGE	PIN-PACKAGE
MAX6400BS_ _-T	-40°C to +85°C	UCSP-4
MAX6401BS_ _-T	-40°C to +85°C	UCSP-4
MAX6402BS_ _-T	-40°C to +85°C	UCSP-4
MAX6403BS_ _-T	-40°C to +85°C	UCSP-4
MAX6404BS_ _-T	-40°C to +85°C	UCSP-4
MAX6405BS_ _-T	-40°C to +85°C	UCSP-4

The MAX6400–MAX6405 are available in factory-set V_{CC} reset thresholds from 2.20V to 4.63V, in approximately 0.1V increments. Choose the desired reset-threshold suffix from Table 1 and insert it in the blank space following "S". There are 21 standard versions with a required order increment of 2500 pieces. Sample stock is generally held on the standard versions only (Table 1). Required order increment is 10,000 pieces for nonstandard versions (Table 2). Contact factory for availability. All devices available in tape-and-reel only.

UCSP reliability is integrally linked to the user's assembly methods, circuit board material, and environment. Refer to the UCSP Reliability Notice in the UCSP Reliability section of this data sheet for more information.

Pin Configuration appears at end of data sheet.

UCSP is a trademark of Maxim Integrated Products, Inc.

µP Supervisory Circuits in 4-Bump (2 × 2) Chip-Scale Package

ABSOLUTE MAXIMUM RATINGS

All voltages measured with respect to GND, unless otherwise noted.

V_{CC} .....-0.3V to +6V
$\overline{RESET}$, RESET (push-pull) .....-0.3V to (V_{CC} + 0.3V)
$\overline{RESET}$ (open-drain).....-0.3V to +6V
$\overline{MR}$ .....-0.3V to (V_{CC} + 0.3V)
Input/Output into Any Pin 20mA

Continuous Power Dissipation (T_A = +70°C)
4-Bump UCSP (derate 3.8mW/°C above +70°C).....303mW
Operating Temperature Range .....-40°C to +85°C
Junction Temperature.....+150°C
Storage Temperature Range .....-65°C to +150°C
Bump Reflow Temperature .....+235°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{CC} = 1.0V to 5.5V, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at V_{CC} = 3.0V and T_A = +25°C.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Supply Voltage Range	V_{CC}	T_A = 0°C to +70°C		1.0		5.5	V
		T_A = -40°C to +85°C		1.2		5.5	
Supply Current	I_{CC}	MAX6400/MAX6401/MAX6402 V_{CC} = 3.0V for $V_{TH} \le$ 2.93V, V_{CC} = 3.2V for $V_{TH} \ge$ 2.93V, no load			0.5	1.0	µA
		V_{CC} = 5.5V, no load			1.0	1.75	
Reset Threshold	V_{TH}	Table 1	T_A = +25°C	V_{TH} - 1.5%	V_{TH}	V_{TH} + 1.5%	V
			T_A = -40°C to +85°C	V_{TH} - 2.5%	V_{TH}	V_{TH} + 2.5%	
Reset Threshold Hysteresis		MAX6400/MAX6401/MAX6402			6.3		mV
		MAX6403/MAX6404/MAX6405			9.5		
Reset Threshold Tempco	ΔV_{TH}/°C				40		ppm/°C
V_{CC} to Reset Delay	t_{RD}	V_{CC} = (V_{TH} +100mV) to (V_{TH} - 100mV)			20		µs
Reset Active Timeout Period	t_{RP}			100	185	280	ms
$\overline{MR}$ Input	V_{IL}	V_{TH} > 4.0V				0.8	V
	V_{IH}			2.0			
	V_{IL}	$V_{TH} \le$ 4.0V				0.2 x V_{CC}	
	V_{IH}			0.7 x V_{CC}			
$\overline{MR}$ Minimum Input Pulse Width	t_{MD}			1			µs
$\overline{MR}$ Glitch Rejection					100		ns
$\overline{MR}$ to Reset Delay Time					200		ns
$\overline{MR}$ Pullup Resistance				25	50	75	kΩ

ELECTRICAL CHARACTERISTICS (continued)

(V_{CC} = 1.0V to 5.5V, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at V_{CC} = 3.0V and T_A = +25°C.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
$\overline{RESET}$ Output Voltage Low (MAX6400/MAX6402/MAX6403/ MAX6405)	V_{OL}	I_{SINK} = 1.6mA, V_{CC} ≥ 2.1V, reset asserted			0.3	V
		I_{SINK} = 100µA, V_{CC} ≥ 1.2V, reset asserted			0.4	
$\overline{RESET}$ Output Voltage High (MAX6400/MAX6403)	V_{OH}	I_{SOURCE} = 500µA, V_{CC} = 3.2V, MAX6400, only, reset not asserted	0.8 x V_{CC}			V
		I_{SOURCE} = 800µA, V_{CC} = 4.5V, V_{TH} ≤ 4.38V, reset not asserted	0.8 x V_{CC}			
		I_{SOURCE} = 800µA, V_{CC} = V_{TH} (max), V_{TH} ≥ 4.5V, reset not asserted	0.8 x V_{CC}			
RESET Output Voltage (MAX6401/MAX6404)	V_{OH}	I_{SOURCE} = 500µA, V_{CC} ≥ 2.1V, reset asserted	0.8 x V_{CC}			V
		I_{SOURCE} = 50µA, V_{CC} ≥ 1.2V, reset asserted	0.8 x V_{CC}			
	V_{OL}	I_{SINK} = 1.2mA, V_{CC} ≥ 3.2V, reset not asserted, MAX6401 only			0.3	
		I_{SINK} = 3.2mA, V_{CC} ≥ 4.5V, reset not asserted, V_{TH} ≤ 4.38V			0.4	
		I_{SINK} = 3.2mA, V_{CC} = V_{TH} (max), V_{TH} ≥ 4.5V, reset not asserted			0.4	
Open-Drain $\overline{RESET}$ Output Leakage Current (Note 2)		$\overline{RESET}$ not asserted			0.1	µA

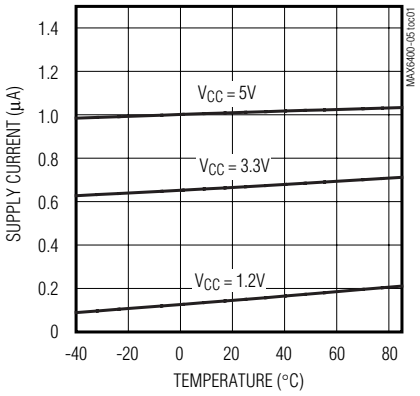
Note 1: Production testing done at +25°C only. Overtemperature limits are guaranteed by design and not production tested.
Note 2: Guaranteed by design.

µP Supervisory Circuits in 4-Bump (2 × 2) Chip-Scale Package

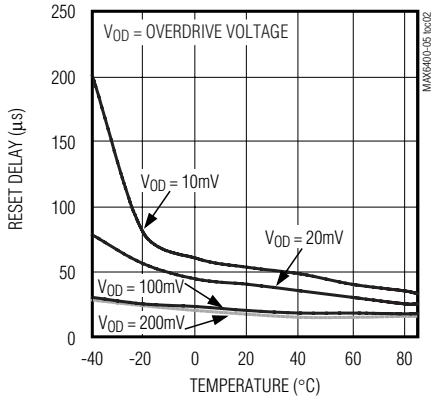
Typical Operating Characteristics

(T_A = +25°C, unless otherwise noted.)

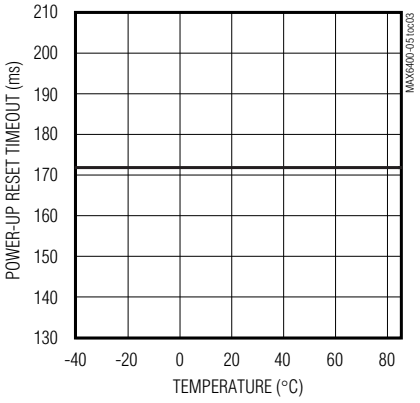
SUPPLY CURRENT vs. TEMPERATURE



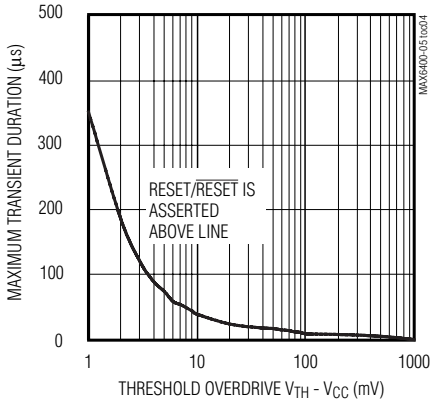
POWER-DOWN RESET DELAY vs. TEMPERATURE



POWER-UP RESET TIMEOUT vs. TEMPERATURE



MAXIMUM TRANSIENT DURATION vs. THRESHOLD OVERDRIVE



Pin Description

PIN		NAME	FUNCTION
MAX6400/MAX6402 MAX6403/MAX6405	MAX6401/MAX6404		
A1	A1	GND	Ground
B1	—	$\overline{RESET}$	Active-Low Reset Output, (Open-Drain or Push-Pull). $\overline{RESET}$ is asserted low when the V_{CC} input is below the selected reset threshold. $\overline{RESET}$ remains low for the reset timeout period after V_{CC} exceeds the device reset threshold. Open-drain outputs require an external pullup resistor.
—	B1	RESET	Active-High Reset Output. RESET remains high while V_{CC} is below the reset threshold and for at least 100ms after V_{CC} rises above the reset threshold.
B2	B2	$\overline{MR}$	Active-Low Manual Reset. Internal 50kΩ pullup to V_{CC}. Pull low to assert a reset. Reset remains asserted as long as $\overline{MR}$ is low and for the reset timeout period after $\overline{MR}$ goes high. Leave unconnected or connect to V_{CC} if unused.
A2	A2	V_{CC}	Supply Voltage and Input for the Reset Threshold Monitor

Detailed Description

Reset Output

A microprocessor's (μP's) reset input starts the μP in a known state. These μP supervisory circuits assert reset to prevent code execution errors during power-up, power-down, or brownout conditions.

$\overline{RESET}$ is guaranteed to be a logic low for V_{CC} down to 1V. Once V_{CC} exceeds the reset threshold, an internal timer keeps $\overline{RESET}$ low for the reset timeout period; after this interval, $\overline{RESET}$ goes high.

If a brownout condition occurs (V_{CC} dips below the reset threshold), $\overline{RESET}$ goes low. Any time V_{CC} goes below the reset threshold, the internal timer resets to zero, and $\overline{RESET}$ goes low. The internal timer starts after V_{CC} returns above the reset threshold, and $\overline{RESET}$ remains low for the reset timeout period.

The manual reset input ($\overline{MR}$) can also initiate a reset, see the *Manual Reset Input* section. The MAX6401/MAX6404 have active-high RESET outputs that are the inverse of the MAX6400/MAX6402/MAX6403/MAX6405 outputs (Figure 1).

Manual Reset Input

Many μP-based products require manual reset capability, allowing the operator, a test technician, or external logic circuit to initiate a reset. A logic low on $\overline{MR}$ asserts reset. Reset remains asserted while $\overline{MR}$ is low, and for the reset active timeout period (t_{RP}) after $\overline{MR}$ returns high. This input has an internal 50kΩ pullup resistor, so it can be left open if it is not used. $\overline{MR}$ can be driven with TTL or CMOS logic levels, or with open-drain/collector outputs. Connect a normally open momentary switch from $\overline{MR}$ to GND to create a manual reset function; external debouncing circuitry is not required. If $\overline{MR}$ is driven from long cables or if the device is used in a noisy environment, connect a 0.1μF capacitor from $\overline{MR}$ to ground to provide additional noise immunity (see Figure 1).

Applications Information

Interfacing to μP with Bidirectional Reset Pins

Since the $\overline{RESET}$ output on the MAX6402/MAX6405 is open-drain, these devices interface easily with (μPs) that have bidirectional reset pins. Connecting the μP supervisor's $\overline{RESET}$ output directly to the microcontroller's (μC's) $\overline{RESET}$ pin with a single pullup resistor allows either device to assert reset (Figure 2).

Negative-Going VCC Transients

These devices are relatively immune to short-duration, negative-going V_{CC} transients (glitches).

The *Typical Operating Characteristics* show the Maximum Transient Duration vs. Reset Threshold Overdrive graph, for which reset pulses are not gener-

µP Supervisory Circuits in 4-Bump (2 × 2) Chip-Scale Package

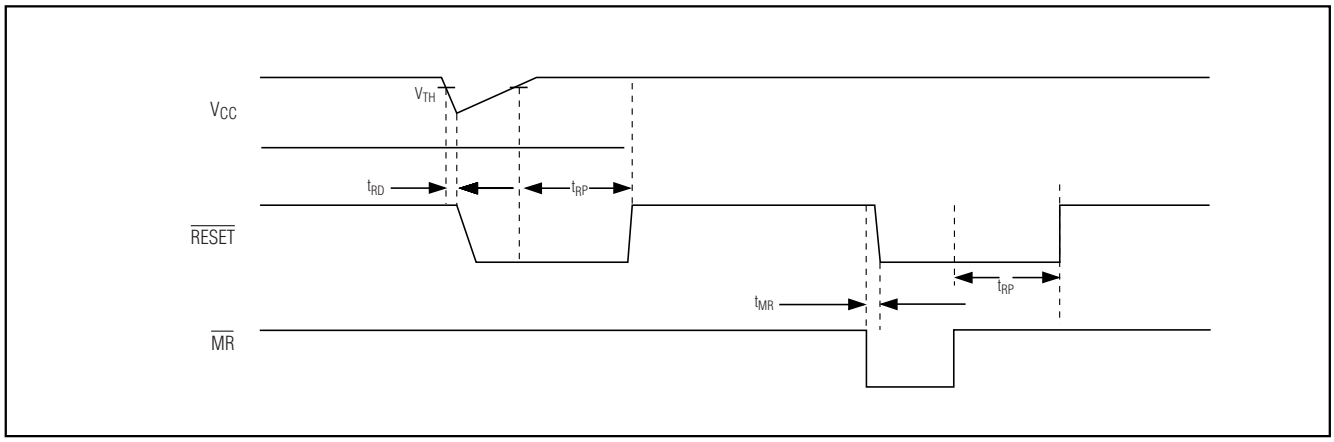


Figure 1. Reset Timing Diagram

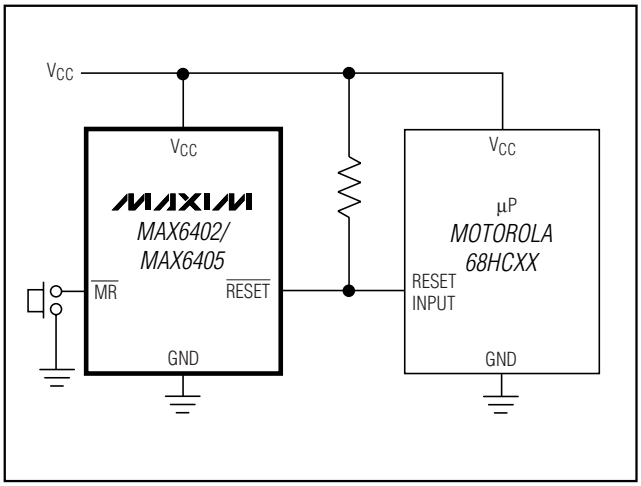


Figure 2. Interfacing to µPs with Bidirectional Reset Pins

ated. The graph shows the maximum pulse width that a negative going V_{CC} transient may typically have when issuing a reset signal. As the amplitude of the transient increases, the maximum allowable pulse width decreases.

Chip Information

TRANSISTOR COUNT: 512

PROCESS: BiCMOS

Table 1. Factory Trimmed Reset Thresholds*

PARTS	SUFFIX	Reset Threshold Voltage, V_{TH} (V)				
		T_A = +25°C			T_A = -40°C to +85°C	
		MIN	TYP	MAX	MIN	MAX
MAX6400BS MAX6401BS MAX6402BS	22*	2.167	2.200	2.233	2.145	2.250
	23*	2.285	2.320	2.355	2.262	2.375
	24	2.364	2.400	2.436	2.340	2.460
	25	2.462	2.500	2.537	2.437	2.562
	26*	2.591	2.630	2.669	2.564	2.692
	27	2.660	2.700	2.741	2.633	2.768
	28	2.758	2.800	2.842	2.730	2.870
	29*	2.886	2.930	2.974	2.857	3.000
	30	2.955	3.000	3.045	2.925	3.075
	31*	3.034	3.080	3.126	3.003	3.150
MAX6403BS MAX6404BS MAX6405BS	33	3.250	3.300	3.350	3.217	3.383
	34	3.349	3.400	3.451	3.315	3.485
	35	3.447	3.500	3.552	3.412	3.587
	36	3.546	3.600	3.654	3.510	3.690
	37	3.644	3.700	3.755	3.607	3.792
	38	3.743	3.800	3.857	3.705	3.895
	39	3.841	3.900	3.958	3.802	3.997
	40	3.940	4.000	4.060	3.900	4.100
	41	4.038	4.100	4.161	3.997	4.202
	42	4.137	4.200	4.263	4.095	4.305
	43	4.235	4.300	4.364	4.192	4.407
	44*	4.314	4.380	4.446	4.270	4.489
	45	4.432	4.500	4.567	4.387	4.612
	46*	4.560	4.630	4.699	4.514	4.746

Factory-trimmed voltage thresholds are available in approximately 100mV increments with a 1.5% room-temperature variance.

**Note: Parts marked with an asterisk (*) are standard versions.*

µP Supervisory Circuits in 4-Bump (2 × 2) Chip-Scale Package

Table 2. Device Marking Codes

PARTS	TOP MARK	PARTS	TOP MARK	PARTS	TOP MARK
MAX6400BS31-T	AAJ	**MAX6401**BS31-T	ABV	**MAX6402**BS31-T	ACF
MAX6400BS30-T	AAI	MAX6401BS30-T	ABU	MAX6402BS30-T	ACE
MAX6400BS29-T	AAH	MAX6401BS29-T	ABT	MAX6402BS29-T	ACD
MAX6400BS28-T	AAG	MAX6401BS28-T	ABS	MAX6402BS28-T	ACC
MAX6400BS27-T	AAF	MAX6401BS27-T	ABR	MAX6402BS27-T	ACB
MAX6400BS26-T	AAE	MAX6401BS26-T	ABQ	MAX6402BS26-T	ACA
MAX6400BS25-T	AAD	MAX6401BS25-T	ABP	MAX6402BS25-T	ABZ
MAX6400BS24-T	AAC	MAX6401BS24-T	ABO	MAX6402BS24-T	ABY
MAX6400BS23-T	AAB	MAX6401BS23-T	ABN	MAX6402BS23-T	ABX
MAX6400BS22-T	AAA	MAX6401BS22-T	ABM	MAX6402BS22-T	ABW

PARTS	TOP MARK	PARTS	TOP MARK	PARTS	TOP MARK
MAX6403BS46-T	ACT	**MAX6404**BS46-T	ADH	**MAX6405**BS46-T	ADV
MAX6403BS45-T	ACS	MAX6404BS45-T	ADG	MAX6405BS45-T	ADU
MAX6403BS44-T	ACR	MAX6404BS44-T	ADF	MAX6405BS44-T	ADT
MAX6403BS43-T	ACQ	MAX6404BS43-T	ADE	MAX6405BS43-T	ADS
MAX6403BS42-T	ACP	MAX6404BS42-T	ADD	MAX6405BS42-T	ADR
MAX6403BS41-T	ACO	MAX6404BS41-T	ADC	MAX6405BS41-T	ADQ
MAX6403BS40-T	ACN	MAX6404BS40-T	ADB	MAX6405BS40-T	ADP
MAX6403BS39-T	ACM	MAX6404BS39-T	ADA	MAX6405BS39-T	ADO
MAX6403BS38-T	ACL	MAX6404BS38-T	ACZ	MAX6405BS38-T	ADN
MAX6403BS37-T	ACK	MAX6404BS37-T	ACY	MAX6405BS37-T	ADM
MAX6403BS36-T	ACJ	MAX6404BS36-T	ACX	MAX6405BS36-T	ADL
MAX6403BS35-T	ACI	MAX6404BS35-T	ACW	MAX6405BS35-T	ADK
MAX6403BS34-T	ACH	MAX6404BS34-T	ACV	MAX6405BS34-T	ADJ
MAX6403BS33-T	ACG	MAX6404BS33-T	ACU	MAX6405BS33-T	ADI

UCSP Reliability

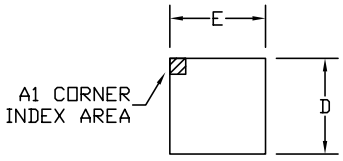
The chip-scale package (UCSP) represents a unique packaging form factor that may not perform equally to a packaged product through traditional mechanical reliability tests. CSP reliability is integrally linked to the user's assembly methods, circuit board material, and usage environment. The user should closely review these areas when considering use of a CSP package. Performance through Operating Life Test and Moisture Resistance remains uncompromised as it is primarily determined by the wafer-fabrication process.

Mechanical stress performance is a greater consideration for a CSP package. CSPs are attached through direct solder contact to the user's PC board, foregoing the inherent stress relief of a packaged product lead frame. Solder joint contact integrity must be considered. Information on Maxim's qualification plan, test data, and recommendations are detailed in the UCSP application note, which can be found on Maxim's website at www.maxim-ic.com.

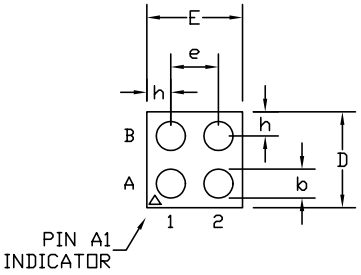
Package Information

4L, UCSP 2x2.EPS

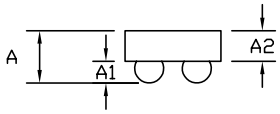
SYMBOL	DIMENSIONS
A	0.022 ±.002
E	0.040 ±.002
D	0.040 ±.002
e	0.0197 BASIC
b	ø 0.0120 BASIC
A1	0.009±.0015
A2	0.013 Ref.
h	0.010 Ref.



TOP VIEW



BOTTOM VIEW



SIDE VIEW

NOTES:
1. ALL DIMENSIONS ARE IN INCHES.
2. MEETS JEDEC MO195.

MAXIM
PROPRIETARY INFORMATION

TITLE: PACKAGE OUTLINE, 4L UCSP, 2x2			
APPROVAL	DOCUMENT CONTROL NO. 21-0117	REV. A	1/1